ADC12DJxx00EVM Quick Start Guide

For Board Revisions E2 and E3 Jim Brinkhurst, High Speed Data Converters Rev. C January 11, 2017 SLAU709



Cautions

 The ADC device on this EVM can consume >3.5W power at maximum clock rate. Therefore the ADC surface temperature can exceed 55°C and should not be touched during operation. The EVM is labeled with a Do Not Touch symbol to re-iterate this warning.



Caution Caution Hot surface. Contact may cause burns. Do not touch

The EVM requires a +5V DC, minimum 3A power source. Since this
power source is not provided with the EVM care must be taken
regarding polarity and voltage setting when connecting the provided
power cable to this supply.

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Notes Regarding Silicon Version

General Note: Evaluation Modules with initial silicon are provided for early evaluation of the ADC12DJxx00 device. Internal evaluation is still underway and current device performance is not fully representative of the final production device. Performance and feature improvements will be made through the development cycle.





Contents

This Quick Start guide is designed to help you get up and running with the preliminary version of the ADC12DJxx00EVM.

- Installing the software
- Hardware list, orientation, and setup
- ADC12DJxx00EVM bring up and GUI features
- TSW14J56 bring up and features
- TSW14J57 bring up and features
- Limitations / errata
- Revision history





Installing the Software

There are three pieces of software required to use this system:

- ADC12DJxx00EVM GUI including configuration files
 - Purpose: To program the devices (clocks, ADC and temp sensor) on-board the EVM
 - Where to get it: Provided USB drive or by contacting local TI Support
 - How to install it: run "setup.exe" and restart if prompted.



Installing the Software (continued)

- High Speed Data Converter Pro software for data capture and evaluation
 - Purpose: To capture the high speed serial data from the ADC12DJxx00, perform an FFT, and show performance results
 - Where to get it: "<u>http://www.ti.com/tool/dataconverterpro-sw</u>"
 - How to install it: run "High Speed Data Converter Pro Installer.exe"
 - Note: Use default file locations to ensure any subsequent patches install correctly

Tip: Uninstall any older versions of HSDC Pro before installing the latest version.



Installing the Software (continued)

- Add necessary files to HSDC Pro for ADC12DJxx00EVM and TSW14J56EVM and/or TSW14J57EVM
- Purpose: To add EVM specific configuration files for the ADC12DJxx00EVM
 - Where to get it: Provided USB drive or by contacting local TI Support
 - Copy files to the following locations
 - Files for TSW14J56EVM Rev D

C:\Program Files (x86)\Texas Instruments\High Speed Data Converter Pro\14J56revD Details\ADC files

• Files for TSW14J57EVM

C:\Program Files (x86)\Texas Instruments\High Speed Data Converter Pro\14J57 Details\ADC files



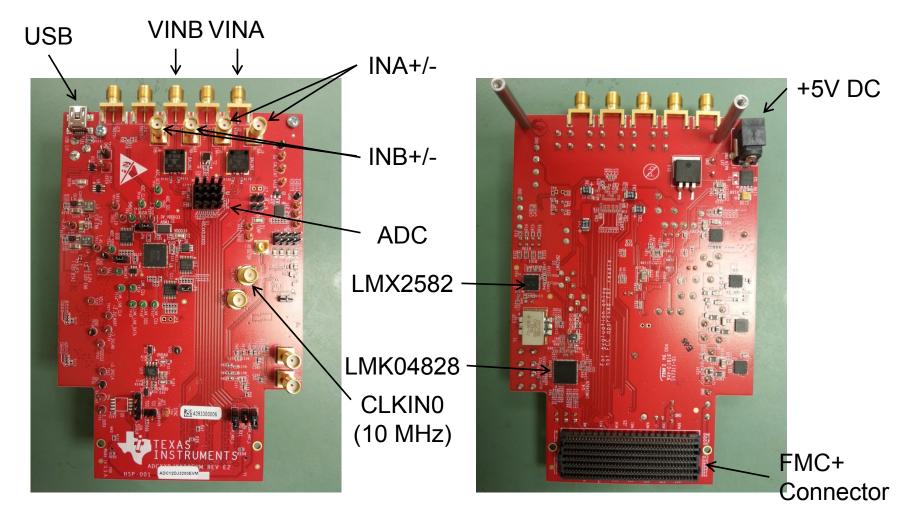
Hardware List

- Verify that the contents of the EVM package are present:
 - (1) ADC12DJxx00EVM
 - (1) FMC+ to FMC adapter (only needed with TSW14J56EVM)
 - (1) 5V power cable
 - (1) mini-USB cable





ADC12DJxx00EVM Key Components



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ADC12DJxx00EVM Features

ADC Block	EVM Feature	Benefits
Serial Configuration Interfaces	ADC, temp sensor, LMK and LMX programmed via header, FMC, and/or mini USB	Program devices via HSDC Pro; compatible with Xilinx [®] data capture boards; multiple methods for debug
Analog Inputs	Populate options for differential AC- coupled, DC-coupled or S/E-in to balun	Optimized solution for flexibility and performance
Serial data / NCO pins	Serial data to FPGA only; NCO pins to header and FMC	Smaller board reduces cost, more true mezzanine form factor yields better reference design
Power	External 5V supply to switching regulators and LDOs to devices	Simplifies power supply scheme, provides reference design
Clocking	LMK04828+LMX2582 on-board solution; external generator option planned	No external generators required for ADC CLK up to 3.2GHz; external generators for maximum flexibility
TimeStamp / SYNC~	S/E and differential SYNC~ ; TimeStamp applied externally	Both features simultaneously available
Temperature Sensor	Read ADC internal and board ambient temperature	Can monitor ADC temp via EVM GUI
Over-range	OR outputs to FMC, header, and LEDs on-board	Visual confirmation is convenience to customer

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Hardware Setup

- 1. Connect the ADC12DJxx00EVM FMC+ connector to the TSW14J56 FMC connector via the supplied FMC+ to FMC adapter.
- Connect 5VDC ≥ 3A power to the TSW14J56. Center pin of connector is +5V. Output ring is GND.
- Connect 5VDC ≥ 3A bench supply to power cable for the ADC12DJxx00EVM. (Red plug or wire is +5V, Black plug or wire is GND) Center pin of connector is +5V. Output ring is GND.



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Hardware Setup (continued)

- 1. Connect the USB cable from the TSW14J56 to the PC (USB 3.0 Cable for TSW14J56 Rev D shown below)
- 2. Connect the USB cable from the ADC12DJxx00EVM to the PC



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Hardware Setup (continued)

- 1. Connect the input signals to the INA+/- and/or INB+/- top mounted SMA connectors as needed. Diagram below shows connections to INA+/- only.
- 2. Optional: Connect the 10 MHz +6dBm signal to the CLKIN0 (J38) SMA connector.
 - 1. This signal should be frequency locked with the signal generators used for the analog inputs.
 - 2. This will allow coherent sampling of signals with respect to the sampling clock and eliminate the need to do windowed FFTs.



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Configure the ADC12DJxx00EVM

Step	To observe
1. Turn on the EVM power supply and slide the TSW14J56 power switch to ON	The EVM "5VIN" and "VDDD33" LEDs are lit.
2. Open the ADC12DJxx00 GUI, using the Low Level tab, program the EVM as directed on the following slides.	After programming, the "LCKD" and "PLL2 LCKD" LEDs are lit to show the LMK04828 has been configured and PLL1 is locked. Note: If a 10MHz reference at CLKIN0 is not supplied the LCKD LED will not be lit but the board will be functional. Coherent sampling will not be possible.





Available EVM Quick-Start Configuration Settings

ADC12DJxx00 GUI								
File Debug Settings Help	File Debug Settings Help							
		AD	C12DJxx	00 GUI				
EVM Control JESD204B NCO Configuration Trim LMK04828 LMX2582 LMX2582 USB Status USB Status								
1. User Inputs		E!						
 #1. Clock Source On-board	#1. Clock Source 0n-board #2a. On-board Fclk Selection Fclk = 2700 MHz Item to be the selected, choose the Fs at #2a. If the external clock is selected, enter the Fs at #2b.							
1000 MHz #3. Decimation and Serial Data Mode JMODE0	1000 MHz #3. Decimation and Serial Data Mode JMODE0 Image: Serial Data Mode JMODE0 Image: Serial Data Mode #3. Decimation and Serial Data Mode Image: Serial Data Mode JMODE0 Image: Serial Data Mode #3. Decimation and Serial Data Mode Image: Serial Data Mode JMODE0 Image: Serial Data Mode #3. Decimation and Serial Data Mode Choose the decimation mode and serial data mode for the ADC. #4. Program Clocks and ADC - once all modes have been selected, press this button to write selections to the PLL/VCO, LMK04828, and ADC.							
2. Temp Sensor:	-1							
ADC Temp 0 degrees C								
LM95233 Local Temp 0 degrees C								
Update Temperatures								
l Idle					HARDWAR	e connected 🛛 🚸 Texas Instruments		

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Available Quick-Start Configuration Settings

- JMODES
 - 0, 1, 2, 3, 4, 5, 6, 7, 9, 10, 11, 13, 14, 15, 16, 17, 18, 19
- Clock Source
 - On-board (default)
 - External
- F_CLK (MHz)
 - 800
 - 1000
 - 1250
 - 1500
 - 1600
 - 2000
 - 2500
 - 2700
 - 3000
 - 3100
 - 3200

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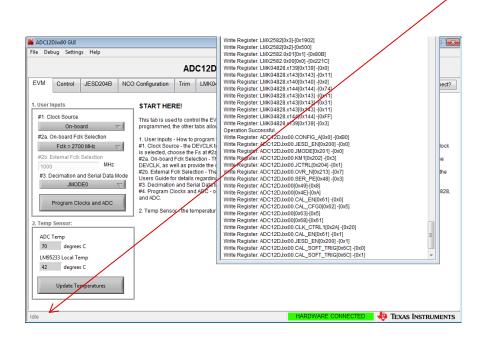
First Configuration

- Keep the default GUI settings:
 - On-board clocking
 - 2700 MHz
 - JMODE0
- Click Program Clocks and ADC





Devices on EVM are Programmed



- If desired, double-click on "Idle" word in lower left corner of GUI to see what registers were written.
- The Status Log Display shown on the following slide will be launched.





Read ADC and Board Temperatures

ADC12	ADC12DJxx00 GUI								
File Det	File Debug Settings Help								
	ADC12DJxx00 GUI								
EVM	EVM Control JESD204B NCO Configuration Trim LMK04828 LMX2582								
1. User I	nputs		START HER	E!					
#1. CI	ock Source On-boa	ard 🗸						DC, and read the temperature. Once the EVM is	
#2b. E 1000 #3. D	On-board Image: construction of the sector of the sect								
2. Temp	Sensor:								
	Temp								
70									
LM95	LM95233 Local Temp 42 degrees C								
	Update Temperatures								
Idle							HARDWAR	E CONNECTED 🛛 👫 TEXAS INSTRUMENTS	
1									

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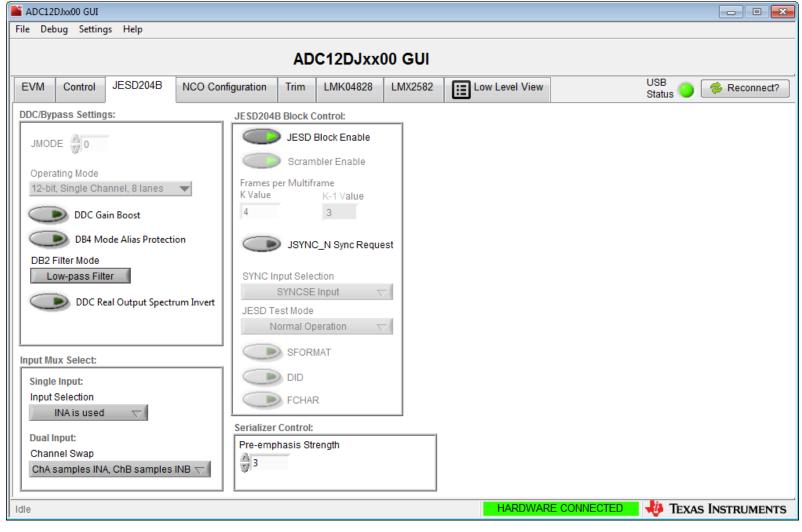
ADC Configuration Tabs - Control

ADC12DJxx00 GUI									
File Debug Settings Help									
ADC12DJxx00 GUI									
EVM Control JESD204B NCO	EVM Control JESD204B NCO Configuration Trim LMK04828 LMX2582 ELow Level View USB Status Status								
Power and Reset:	Calibration:		Gain	and Offset:					
Soft Reset Reset Device Registers POWER DOWN Identification: Chip Type	Disable Cal Block to Enable Fo Enable Fo FG Calibration ADC ADC B and A	oreground Cal preground Offset Selection	CAL OF	It A: in Full Scale INA 2180 789.190 set ADC A 047 -0.007 set ADC B	mVpp mV	offset AD 2047 Offset AD	-0.007	mVpp mV	
Chip Version 1 Vendor ID 451	Enable Ba	ackground Offset	CAL 0	047 -0.007 fset ADC C 2047 -0.007	mV	2047 Offset AD	-0.007 OC C -0.007	mV mV	
ADC Test Pattern Mode:	Check CAL Status CAL_GOOD CAL_STOPPED FG_DONE	PD_A	сн	-range: er-range Threshold 42 er-range Threshold ;	-0.488	dBFS			
Input Resistor Trim:	CAL Status Select CALSTAT matches			71	-3.5	dBFS			
Termination Resistor Trim	CAL Trigger Source			R Monitoring Period	1024	ADC Samples			
Idle				HARD	WARE CO	ONNECTED	🦊 Texas	5 Instrum	ENTS

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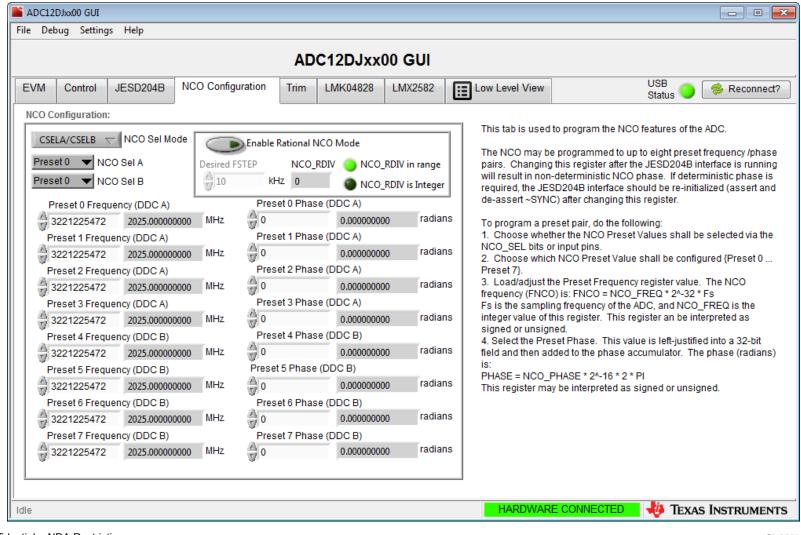
ADC Configuration Tabs JMODES, INPUTS, JESD204B



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ADC Configuration Tabs NCO Settings



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GUI – Low Level View – Devices/Registers

File Debug Settings Help						
The Debug Settings Thep						
ADC12DJxx00 GUI						
EVM Control JESD204B NCO Configuration Tr	im LMK048	28 LMX2	2582	w Level View	USB 🥥 🥔 Reconnect?	
Register Map 🗒 🖻 🏷 🧐 🗔 👼			Update Mode			
Register Name Address Default	Mode Size	Value 15	5 14 13 12 11	1 10 9 8 🔺		
ADC12DJxx00				=		
CONFIG_A 0x00 0x30	R/W 8	0x30				
DEVICE_CONFIG 0x02 0x00	R/W 8	0x00				
CHIP_TYPE 0x03 0x03	R 8	0x03				
CHIP_ID_0 0x04 0x20	R 8	0x20				
CHIP_ID_1 0x05 0x00	R 8	0x00				
CHIP_VER 0x06 0x01 VENDOR ID 0 0x0C 0x51	R 8 R 8	0x01 0x51				
VENDOR_ID_0 0x0C 0x51 VENDOR_ID_1 0x0D 0x04	R 8	0x51 0x04				
USR0 0x10 0x00	RW 8	0x04 0x00				
AC_CTRL1 0x23 0x00	R/W 8	0x00				
CLK CTRL0 0x29 0x00	R/W 8	0x00				
CLK_CTRL1 0x2A 0x00	R/W 8	0x00				
SYSREF_POS_0 0x2C 0x00	R 8	0x00				
SYSREF_POS_1 0x2D 0x00	R 8	0x00				
SYSREF_POS_2 0x2E 0x00	R 8	0x00				
FS_RANGE_A_0 0x30 0xC4	R/W 8	0xC4				
FS_RANGE_A_1 0x31 0xA4	R/W 8	0xA4				
FS_RANGE_B_0 0x32 0xC4	R/W 8	0xC4				
FS_RANGE_B_1 0x33 0xA4	R/W 8	0xA4				
۰ III III III III III III III III III I				•		
Register Description						
			Block	Address	Write Data Read Data Generic	
			DIUCK			
				▼ × 0	× 0 × 0	
		-			Write Register Read Register	
Idle				HARDWARE CONNECTE	d 🐌 Texas Instruments	

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Configure the TSW14J56 (1/2)

ON/OFF power switch at ON

Texas Instruments ADCs \rightarrow

Click the "Select ADC" pull-down

ADC12DJxx00 JMODE0

ADC12DJxx00 JMODE2

ADC12DJxx00 JMODE*

Tip: In case of incorrect LED pattern or capture

problems, press "CPU Reset" button and/or click

"Instrument Options>Reset Board" from HSDC Pro

Choose one of the following:

Select 'Yes' to download the

Firmware for the ADC

 $(Start \rightarrow Programs \rightarrow$

To do / observe

Multiple LEDs are lit

Accept the board selection.

If multiple TSW' boards are

Correct LED pattern after

connected, select the appropriate model/serial

clicking Capture:

D3. D6. D7 = OFF

D1, D5 – N/A

D4 = blinking

D8 = ON

number

How to

position.

HSDC Pro)

٠

Step

Pro

mode

1. J56 is on from

previous step 2.

2. Open HSDC

3. Configure the

Firmware for the

desired operating

corresponding to the current EVM

configuration

GUI.

Select The Serial number	
T	Serial Numbers A 30527H5-TSW14J56revD
📀 ок	Cancel
	are. Please select a device to load into the board.
🔯 High Speed Data Converter P	Pro v4.10
File Instrument Options Da	ta Capture Options Test Options Device GUI Options
INSTRUMENTS ADC12DJ2700_JMK0E0 ADC12DJ2700_JMK0E0 ADC12DJ2700_JMK ADC12J4000_D10_ ADC12J4000_D20_	€5535- 8 9
Do you want	t to update the Firmware for ADC?

Please Wait



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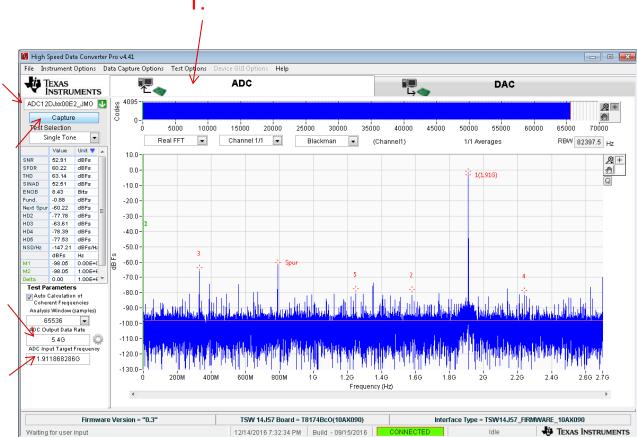
Configure the TSW14J56 (2/2)

5.

3.

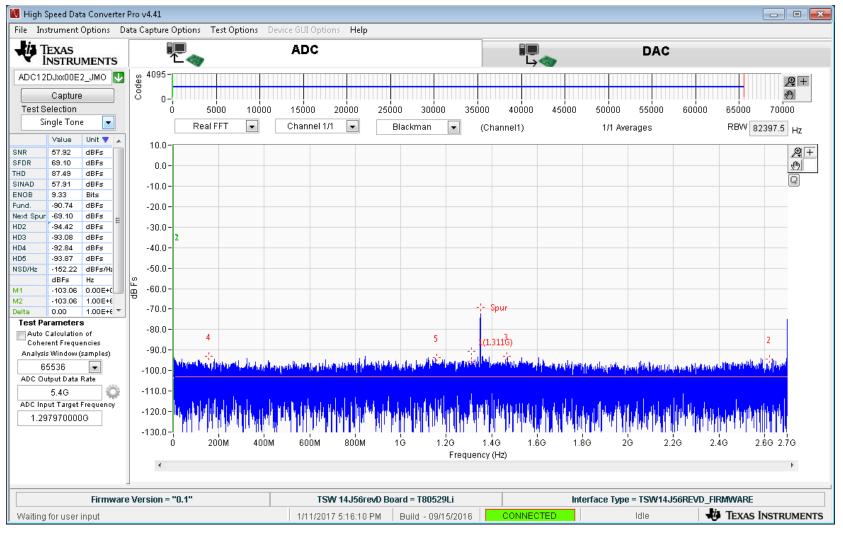
- 1. Select the leftmost "ADC" tab
- 2.Select the 2. "ADC12DJxx00_JMODE0"
- 3.Enter the ADC Output Data Rate = 5.4G
- 4.Enter the ADC Input Target Frequency. For this example, Fin = 1.91GHz
- 5. Click the Capture button to collect data

Note: Refer to the user manual for High Speed Data Converter Pro software for more details and options.





Captured Data Results – Signal Off



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In Case of Data Capture Timeout

M 💌
Read DDR to file TIMED_OUT_ERROR Possible reasons for Time Out Error: 1.FPGA may be in reset. 2.Clock from ADC EVM is not received by TSW Board. Please check if D4 LED is blinking. 3.SYNC is not established between ADC and FPGA. Please check if D3 LED is OFF. Possible reasons for SYNC Failure: a.JESD Ref clock Input Frequency to the TSW board from ADC EVM is not correct. b.JESD configuration is not same in ADC and the INI file selected.
OK

- If capture fails an error message will appear
- Possible Causes
 - Incompatible settings between ADC EVM and HSDC Pro
 - Double check EVM configuration modes set and HSDC Pro device selection and ADC Output Data Rate field. Ensure upper case G and M are used.
 - Capture firmware has lost sync with ADC EVM.
 - Select "Instrument Options>Reset Board" and try to capture again.





Apply Test Signal and Capture

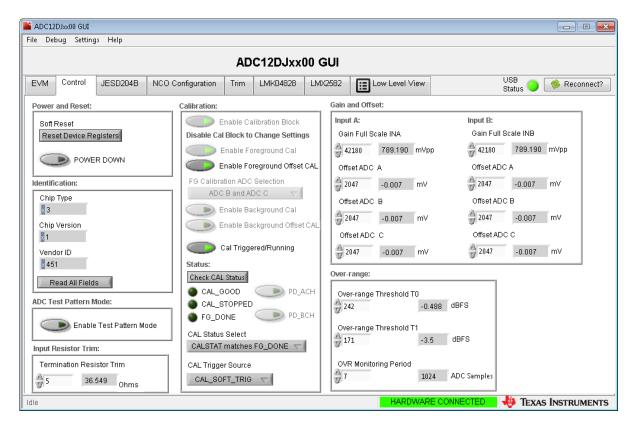
- Once a successful capture has been done the test signal can be applied and evaluation done.
- It is important that the ADC calibration is properly done before evaluation.
- Foreground Calibration
 - Once device temperature is stable re-calibrate by following the procedure on the following slide.
- Background Calibration
 - If the device is in background calibration mode, it continuously selfcalibrates and no additional steps need to be taken.





Trigger Calibration via High Level Control

- Trigger a Foreground Calibration
 - Click on Cal Triggered/Running button on Control tab twice



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Captured Data Results – Signal On

File Instrumente Options Text Options Device Options Text Options Text Options Device Options Text Options <thtext options<="" th=""> Text Options</thtext>	🚺 High Speed Data Converter Pro v4.41		
ACC122Jud0E2_MO g 995 5000 10000 15000 20000 35000 40000 45000 50000 65000 70000 TestSelecton III Real FFT Channel1/I Blackman (Channel1) 1/1 Averages RBW 8237.5 Hz NNR<	File Instrument Options Data Capture Options Test Options	Device GUI Options Help	
Test Selection 5 5000 10000 15000 20000 25000 30000 35000 40000 45000 5000 6000 6500 6000 6500 70000 SNR 50.80 defa defa 10.0	▼ INSTRUMENTS □ □ 🧠	ADC	DAC
Test Selection 5000 10000 15000 20000 25000 30000 35000 40000 45000 50000 65000	ADC12DJxx00E2_JMO 🛂 🧝 4095-		2 +
Test Selection 5000 10000 12600 20000 22600 30000 35000 6000 65000 66000 65000 70000 SNR 62.86 deFe 0.0	Capture 8 0-		(A)
Value Unit <		00 15000 20000 25000 30000 35000	0 40000 45000 50000 55000 60000 65000 70000
Value Value Unit Value Val	Single Tone 💌 Real FFT 💌	Channel 1/1 💌 Blackman 💌 (C	Channel1) 1/1 Averages RBW 82397.5 Hz
SNR 52.89 BF# SFR 53.65 GFE SNA 54.9 GFE Fund 0.0 - 1.0.0 - - Pund 0.0 - 1.0.0 - - Pund 0.0 - 1.0.0 - - Pund 0.0 - 1.0.0 - - -20.0 - - No2 0.0 - 1.0.0 - - -20.0 - - -20.0 - - -20.0 - - -20.0 - - -20.0 - - -20.0 - - -20.0 - - -20.0 - - -20.0 - - -20.0 - - -20.0 - - -20.0 - - -20.0 - - -	Value Unit Value 10.0-		
ENC0 64.8 Bits Hext Spur 59.85 dBFs HD2 61.30 dBFs HD2 61.30 dBFs HD3 63.22 dBFs HD4 75.00 dBFs HD5 7.50.0 dBFs HD4 75.00 dBFs HD5 7.50.0 dBFs HD5 7.0.0 -5.0.0 S -70.0 -5.2 AD2 -70.0 -80.0 -90.0 -90.0 -90.0 -100.0 -10.0 -10.0 1.911868286G -10.0 -10.0 -130.0 <	SNR 52.89 dBFs		2 +
ENCO 4.4 Find 698 HO2 613.0 HO2 613.0 HO3 632 HO4 750.0 HO5 75.00 HO5 75.00 HO5 60.0 -50.0 3 -50.0 -50.0 Bets 0.00 -70.0 -50.0 -60.0 -70.0 -70.0 -60.0 -70.0 -70.0 Bets 0.00 Bets 0.00 1.00.0 -70.0 -70.0 -70.0 -80.0 -80.0 -80.0 -90.0 -90.0 -90.0 -100.0 -70.0 -100.0 -70.0 -100.0 -70.0 -100.0 -70.0 -100.0 -70.0 -100.0 -70.0 -100.0 -70.0 -100.0 -70.0 -100.0 -70.0 -100.0 -70.0 -100.0 -7	0.0		
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H03 -53.82 dBF= H04 -40.0 H05 -75.00 dBF= H05 -40.0 H05 -76.00 -3 -50.0 H05 -76.00 -3 -50.0 H05 -76.00 -60.0 -70.0 H05 -76.00 -60.0 -70.0 H04 -76.00 -60.0 -70.0 H05 -76.00 -60.0 -70.0 H05 -76.00 -60.0 -70.0 H05 -76.00 -60.0 -70.0 H05 -70.0 -5 -4 H04 -76.00 -60.0 -70.0 H05 -70.0 -70.0 -70.0 H04 -76.00 -70.0 -70.0 H04 -76.00 -70.0 -70.0 H05 -76.00 -70.0 -70.0 H05 -65.05 -70.0 -100.0 H05 -70.0 -70.0 -70.0 H05 -65.05 -70.0 -100.0 H05 -60.00 -70.0 -70.0	20.0		
Hud -76.00 dBFs HUS/Hz -76.80 dBFs HK M1 -98.03 0.00E+C Defs Hz M2 -98.03 1.00E+C Defs Hz M2 -98.03 1.00E+C M2 -98.03 1.00E+	00.0		
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ADC Input Target Frequency 1.911868286G -120.0		table and the later of the second	and the second states of the second
1.9118682866 -130.0 - 200M 400M 600M 800M 1G 1.2G 1.4G 1.6G 1.8G 2G 2.2G 2.4G 2.6G 2.7G Frequency (Hz)	ADC Input Target Frequency	Reflered a billing and a state of all a state of a state of the state of a state of	rit a shi katalar ni ka mila ka mala ka katalar ka shi ka
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	0 200M 400		
Firmware Version = "0.3" TSW 14.J57 Board = T8174BcO(10AX090) Interface Type = TSW14.J57 FIRMWARE 10AX090	۲	11040010	
Firmware Version = "0.3" TSW 14J57 Board = T8174BcO(10AX090) Interface Type = TSW14J57 FIRMWARE 10AX090			
	Firmware Version = "0.3"	TSW 14J57 Board = T8174BcO(10AX090)	Interface Type = TSW14J57_FIRMWARE_10AX090
Waiting for user input 12/14/2016 7:33:39 PM Build - 09/15/2016 CONNECTED Idle 🐺 TEXAS INSTRUMENTS	Waiting for user input	12/14/2016 7:33:39 PM Build - 09/15/2016	CONNECTED Idle 🛷 Texas Instruments

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Enable ADC Test Pattern Output

ADC12DJxx00 GUI File Debug Settings Help							- • •
ADC12DJxx00 GUI							
EVM Control JESD204B NCO Configuration Trim LMK04828 LMK2582 III Low Level View USB Status Status							
Power and Reset:	Calibration:		Gain a	ind Offset:			
Soft Reset Reset Device Registers POWER DOWN Identification: Chip Type 3 Chip Version 4 Vendor ID	Disable Cal Block to Enable Fo FG Calibration ADC ADC B and A Enable Bi Enable Bi	oreground Cal preground Offset Selection	CAL Offs	n Full Scale INA 2180 789.190 m set ADC A 047 -0.007 m set ADC B 047 -0.007 m set ADC C		-0.007 DC B -0.007	mVpp mV mV
451 Read All Fields ADC Test Pattern Mode: Enable Test Pattern Mode Input Resistor Trim: Termination Resistor Trim 5 36.549 Ohms	Status: Check CAL Status CAL_GOOD CAL_STOPPED FG_DONE CAL Status Select CALSTAT matcher CAL Trigger Source CAL SoFT_TRIC	PD_E	CH Over- CH Ove	range: r-range Threshold TO 12 r-range Threshold T1 1 R Monitoring Period	-0.498 dBFS -3.5 dBFS 1024 ADC Samples		
Idle				HARDW	ARE CONNECTED	🦊 Texas	5 INSTRUMENTS

- Click on Enable Test Pattern Mode button in lower left of Control tab
- Click again to Disable





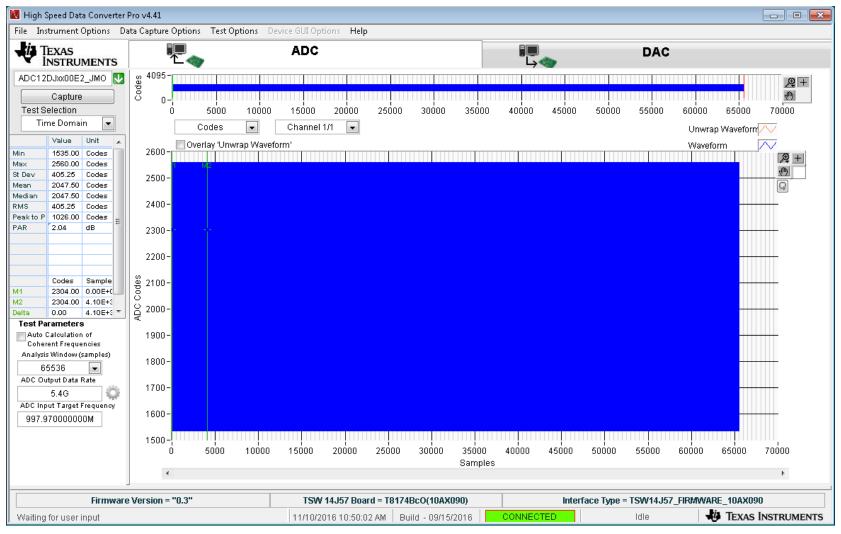
ADC TPM Capture Results

🚺 High Speed Data Converter Pro	o v4.41				
File Instrument Options Data	Capture Options Test Options	Device GUI Options Help			
TEXAS INSTRUMENTS	正	ADC	i III Li	DAC	
ADC12DJxx00E2_JMO 🛂 💡	ω ⁴⁰⁹⁵ -			1 1 1 1 1 1 1 1 1 1	
	8 4095- 0			<u></u>	
Test Selection Single Tone	0 5000 1000		35000 40000 45000 50000	55000 60000 65000 70000	
Value Unit Value	Real FFT 💌	Channel 1/1 💌 Blackman 💌	(Channel1) 1/1 Ave	rages RBW 82397.5 Hz	
SNR 159.08 dBFs SFDR 168.11 dBFs	10.0-		3	@ +	
THD 98.85 dBFs	0.0-		<u>,</u>	<u>@</u>	
SINAD 159.08 dBFs ENOB 26.13 Bits	-10.0-				
Fund8.06 dBFs Next Spur -168.11 dBFs	-20.0-				
HD2 -98.85 dBFs HD3 -8.06 dBFs	-30.0-2				
HD4 -45.46 dBFs HD5 -8.06 dBFs	-40.0-				
NSD/Hz -253.39 dBFs/Hz	-50.0-				
dBFs Hz 00 M1 -204.23 0.00E+(-60.0-				
M2 -204.23 1.00E+6 Delta 0.00 1.00E+6	-70.0-				
Test Parameters Auto Calculation of	-80.0-				
Coherent Frequencies Analysis Window (samples)	-90.0-			2	
65536	-100.0-				
ADC Output Data Rate 5.4G	-110.0-				
ADC Input Target Frequency 997.970000000M	-120.0-				
	-130.0-				
	0 200M 400		1.4G 1.6G 1.8G 24 quency (Hz)	G 2.2G 2.4G 2.6G 2.7G	
	•		·	۲	
Firmware Vi	Firmware Version = "0.3" TSW 14J57 Board = T8174BcO(10AX090) Interface Type = TSW14J57_FIRMWARE_10AX090				
Waiting for user input		11/10/2016 10:44:49 AM Build - 09/15/20		Idle Texas Instruments	

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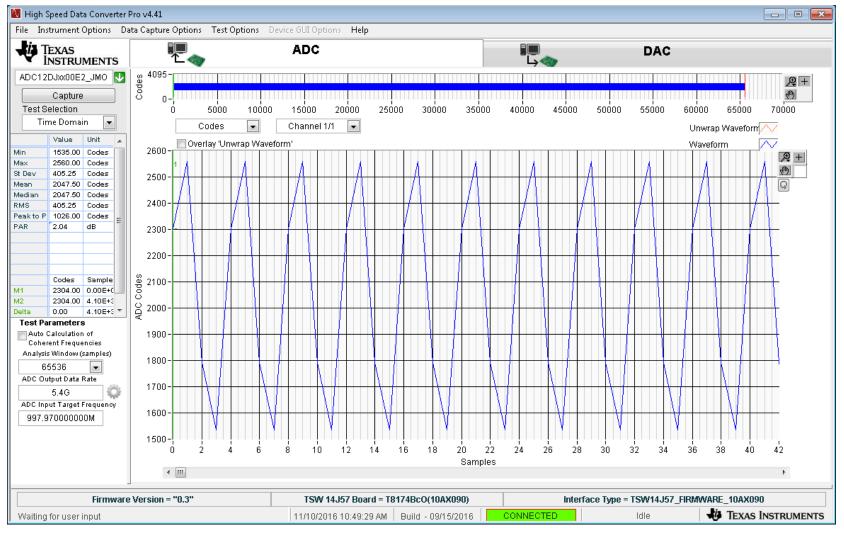
ADC TPM Capture Results – Time Domain



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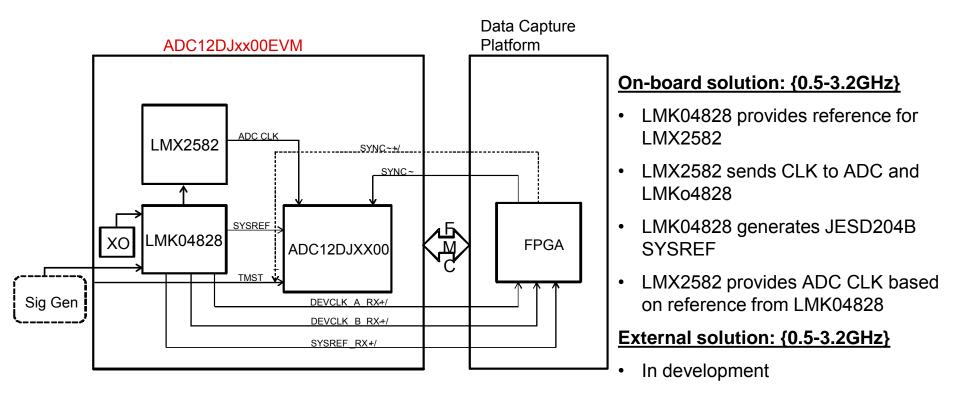
ADC TPM Capture Results – Zoomed In



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EVM Clocking Block Diagram

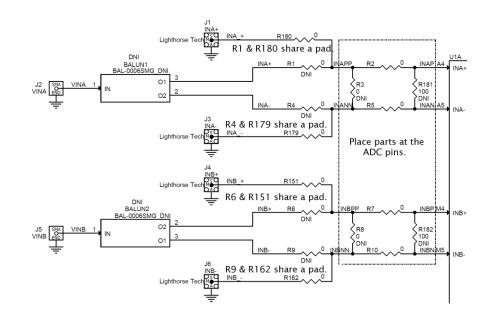






Analog Inputs

• The EVM may be configured for several different analog input options.



Coupling	Input	SMA to Use	R1, R4, R6, R9	R151, R162, R179, R180
AC (default)	S/E Balun {500kHz, 5GHz}	VINA, VINB	0Ω	DNI
DC	Differential	INA+ / INA- INB+ / INB-	DNI	0Ω
AC	Differential	INA+ / INA- INB+ / INB-	DNI	0.1uF SLAU709 - 36



Limitations and Errata

- 1. The board is configured for AC-coupled Single Ended input via a balun. If a differential input is needed the board must be reconfigured.
- 2. Read-back from the LMX2582 does not function because the dual/use readback pin is being used for a PLL Lock Detect function.





Revision History

- Rev B (December 2016) Updated for latest EVM GUI
- Rev C (January 2017) Updated Captured Data Results Signal Off plot, corrected details for TSW14J56EVM status LEDs





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 - 3.1 United States
 - 3.1.1 Notice applicable to EVMs not FCC-Approved:

FCC NOTICE: This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

3.1.2 For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:

CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- · Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- · Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- · Consult the dealer or an experienced radio/TV technician for help.

3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210

Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concerning EVMs Including Detachable Antennas:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur

3.3 Japan

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If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required to follow the instructions set forth by Radio Law of Japan, which includes, but is not limited to, the instructions below with respect to EVMs (which for the avoidance of doubt are stated strictly for convenience and should be verified by User):

- 1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
- 2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
- 3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

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 - 3.4.1 For EVMs subject to EU Directive 2014/30/EU (Electromagnetic Compatibility Directive):

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